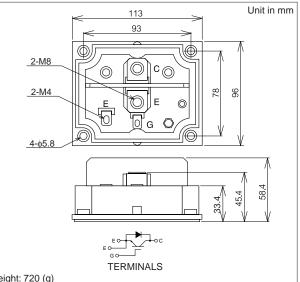
3N400C33

Silicon N-channel IGBT

OUTLINE DRAWING

FEATURES

- * High thermal fatigue durability. (delta Tc=70°C,N>20,000cycles)
- * low noise due to built-in free-wheeling diode - ultra soft fast recovery diode(USFD).
- *High speed, low loss IGBT module.
- *Low driving power due to low input capacitance MOS gate.
- *High reliability, high durability module.
- * Isolated head sink (terminal to base).



Weight: 720 (g)

Item		Symbol	Unit	MBN400C33A	
Collector Emitter Voltage		V _{CES}	V	3,300	
Gate Emitter Voltage		V _{GES}	V	±20	
Collector Current	DC	lc	Α	400	
	1ms	Icp	A	800	
Forward Current	DC	IF	٨	400	
	1ms	I _{FM}	A	800	
Collector Power Dissip	ation	Pc	W	4,000	
Junction Temperature		Tj	С°	-40 ~ +125	
Storage Temperature		T _{stg}	°C	-40 ~ +125	
Isolation Voltage		VISO	V _{RMS}	5,400(AC 1 minute)	
Screw Torque	Terminals(M4/M8)	-	N.m	2/10 (1)	
	Mounting(M5)	-		2.8 (2)	

ABSOLUTE MAXIMUM RATINGS (Tc=25°C)

Notes: (1)Recommended Value 1.8±0.2/9±1N.m

(2)Recommended Value 2.6±0.2N.m

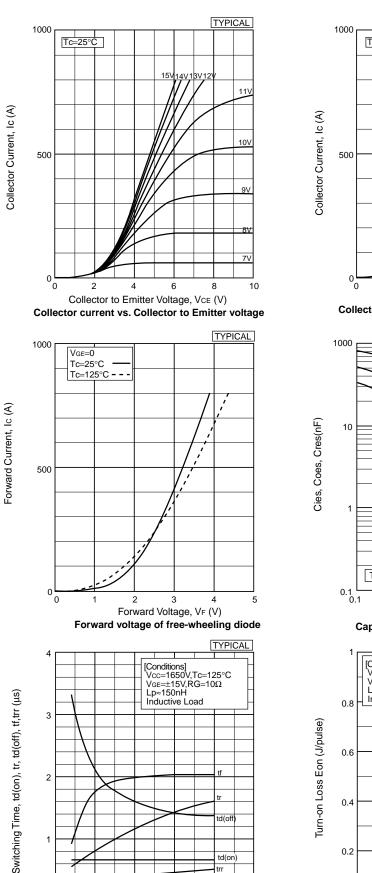
CHARACTERISTICS (Tc=25°C)

Item		Symbol	Unit	Min.	Тур.	Max.	Test Conditions
Collector Emitter Cut-Off Current		I _{CES}	mA	-	-	4.0	V _{CE} =3,300V,V _{GE} =0V
Gate Emitter Leakage Current		I _{GES}	nA	-	-	±200	V _{GE} =±20V,V _{CE} =0V
Collector Emitter Saturation Voltage		V _{CE(sat)}	V	-	4.5	5.5	I _C =400A,V _{GE} =15V
Gate Emitter Threshold Voltage		V _{GE(TO)}	V	4.0	5.5	7.0	V _{CE} =10V, I _C =400mA
Input Capacitance		Cies	nF	-	50	-	V _{CE} =10V,V _{GE} =0V,f=100KHz
Switching Times	Rise Time	tr		-	1.6	2.6	V _{CC} =1,650V,Ic=400A
	Turn On Time	t _{on}	μS	-	2.3	3.2	L=150nH
	Fall Time	tr		-	2.1	2.8	$R_G=10\Omega$ (3)
	Turn Off Time	t _{off}		-	3.4	5.3	V _{GE} =±15V Tc=125°C
Peak Forward Voltage Drop		V _{FM}	V	-	3.0	4.0	-Ic=400A,V _{GE} =0V
Reverse Recovery Time		t _{rr}	μS	-	0.5	0.9	Vcc=1,650V,-lc=400A,L=150nH, Tc=125°C (4)
Thermal Impedance	IGBT	Rth(j-c)	°C/W	-	-	0.025	Junction to case
	FWD	Rth(j-c)		-	-	0.05	

Notes:(3) R_G value is the test condition's value for decision of the switching times, not recommended value. Determine the suitable R_G value after the measurement of switching waveforms

(overshoot voltage,etc.)with appliance mounted.

(4) Counter arm IGBT V_{GE}=-15V



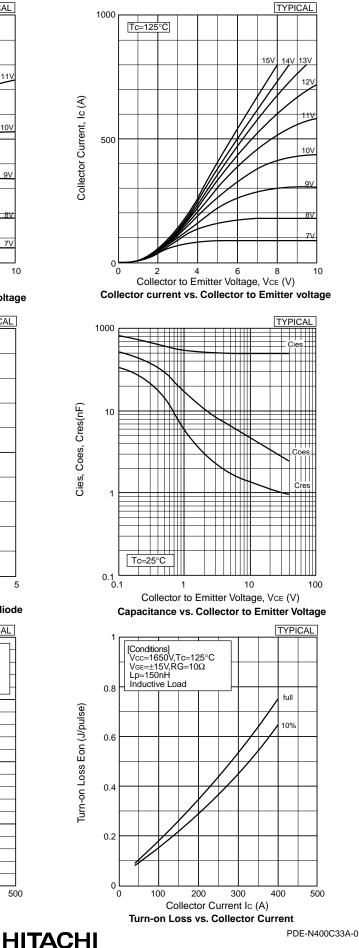
trr

400

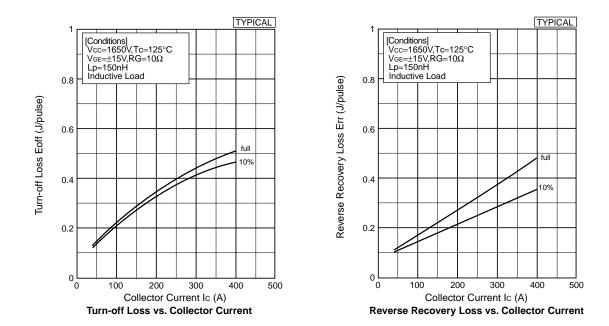
500

100 200 300 Collector Current, Ic(A)

Switching time vs. Collector current



0 · 0



HITACHI POWER SEMICONDUCTORS

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